

Epitaxial Growth of Room-Temperature Ferrimagnetic Semiconductor Thin Films Based on $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ Solid Solution

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Spinel-type $0.4\text{Fe}_3\text{O}_4\cdot 0.6\text{Fe}_2\text{TiO}_4$ (molar ratio) solid solution thin films have been deposited on *c*-sapphire substrates by a pulsed laser deposition technique. A single phase of (111)-oriented solid solution can be obtained by adjusting the oxygen partial pressure and substrate temperature. The epitaxial solid solution thin film exhibits ferrimagnetism with Curie temperature above room temperature and is a semiconductor with *n*-type conduction carriers. Anomalous Hall effect is observed at room temperature for the solid solution thin films, implying the presence of spin-polarized charge carriers. [doi:10.2320/matertrans.MC200804]

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1. Introduction

Recently, materials having high spin polarization of conducting charge carriers have attracted considerable attention due to their potential application in spintronics, a technology simultaneously utilizing both the charge and spin degrees of freedom of carriers.¹⁾ In particular, magnetite (Fe_3O_4) is a promising candidate for functional spintronics devices that operate efficiently at room temperature, because it has high Curie temperature ($T_c \sim 860$ K) and is theoretically predicted to be a half-metal with 100% spin polarization.^{2,3)} Fe_3O_4 has inverse spinel-type structure ($Fd\bar{3}m$) with a face-centered cubic (fcc) oxide ion sublattice, in which half of Fe^{3+} ions occupy the tetrahedral (A) sites, and the other half of Fe^{3+} ions and all Fe^{2+} ions are located at the octahedral (B) sites. The superexchange interaction between Fe^{3+} ions in the A and B sites plays the most important role in magnetic structure and transition of Fe_3O_4 , while the electrical conduction stems from the electron hopping between Fe^{3+} and Fe^{2+} ions in the B sites. The device implementation such as magnetic tunnel junctions using Fe_3O_4 as ferromagnetic electrodes has been demonstrated,⁴⁾ although the tunnel magnetoresistance effect near room temperature is much lower than would be expected for the bulk. Very recently, spinel-type $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{MO}_4$ solid solutions ($M = \text{Mn}^{2+}, \text{Zn}^{2+}$), where M^{2+} ions preferentially occupy the A-sites in the spinel structure, have been exploited for application in semiconductor spintronics.⁵⁻⁷⁾

Here we have focused on the spinel-type solid solutions of Fe_3O_4 and Fe_2TiO_4 (ülvospinel). According to previous studies, bulk specimens of $(1-x)\text{Fe}_3\text{O}_4\text{-}x\text{Fe}_2\text{TiO}_4$ (molar ratio) forms a complete series of solid solutions in a range of $0 < x < 1$.⁸⁻¹⁰⁾ The uniqueness of this solid solution system lies in the fact that the conduction type can be easily controlled by changing the chemical composition *x*; *n*-type conduction is obtained for the compositions of $x \leq 0.6$, while the compositions of $x \geq 0.7$ show *p*-type conduction.¹⁰⁾ In addition, the solid solution system has superiority that T_c of some compounds ($x < 0.8$) is above room temperature

regardless of the conduction type.⁸⁾ In spite of such intriguing properties, there exist no reports on preparation of the $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution in the form of thin films, to the best of our knowledge. In this study, we have prepared $0.4\text{Fe}_3\text{O}_4\cdot 0.6\text{Fe}_2\text{TiO}_4$ solid solution thin films on sapphire substrates using a pulsed laser deposition (PLD) technique and examined their structural, electrical, and magnetic properties.

2. Experimental Procedures

Thin films with $0.4\text{Fe}_3\text{O}_4\cdot 0.6\text{Fe}_2\text{TiO}_4$ composition (molar ratio) were grown on the (0001) surface (*c*-plane) of sapphire ($\alpha\text{-Al}_2\text{O}_3$ single crystal) substrates by a PLD technique. The *c*-sapphire substrates were annealed at 1000°C in air for 3 h to obtain atomically flat surface. The target for PLD was prepared from reagent-grade $\alpha\text{-Fe}_2\text{O}_3$ and TiO_2 by the solid-state reaction; first, the mixture of $\alpha\text{-Fe}_2\text{O}_3$ and TiO_2 powders was sintered at 1200°C for 12 h in air, and then heat-treated in $\text{CO}(40\%)\text{-CO}_2(\text{balance})$ atmosphere at 800°C for 24 h in order to convert some of Fe^{3+} to Fe^{2+} ions. The deposition chamber had a base pressure of $\sim 10^{-6}$ Pa, and the target to substrate distance was 3.5 cm. A focused KrF excimer laser with a wavelength of 248 nm and a pulse duration of 20 ns was used as a light source for PLD. The repetition frequency was 2 Hz, the laser fluence was about 1.3 J/cm^2 , and the deposition rate was 0.67 nm/min. To obtain optimal deposition conditions, oxygen partial pressure, P_{O_2} , and substrate temperature, T_s , were varied from 1.0×10^{-5} to 1.0×10^{-3} Pa and from 500 to 700°C , respectively.

The thickness and chemical composition of thin film were determined by Rutherford backscattering spectroscopy (RBS) using 2.0 MeV He^{2+} . The analysis of RBS spectra with SIMNRA simulation program revealed that the film thickness was 40 nm and that the ratio of Fe to Ti was typically 0.799 : 0.201, consistent with the value expected from the chemical composition of $0.4\text{Fe}_3\text{O}_4\cdot 0.6\text{Fe}_2\text{TiO}_4$. X-ray diffraction (XRD) analysis with $\text{Cu K}\alpha$ radiation (Rigaku, SLX2500K and ATX-G) was performed in $2\theta/\omega$ scans (out-of-plane), $2\theta_\chi/\phi$ scans (in-plane), ω scans (rocking curve), and ϕ -scans. Magnetization as a function of external

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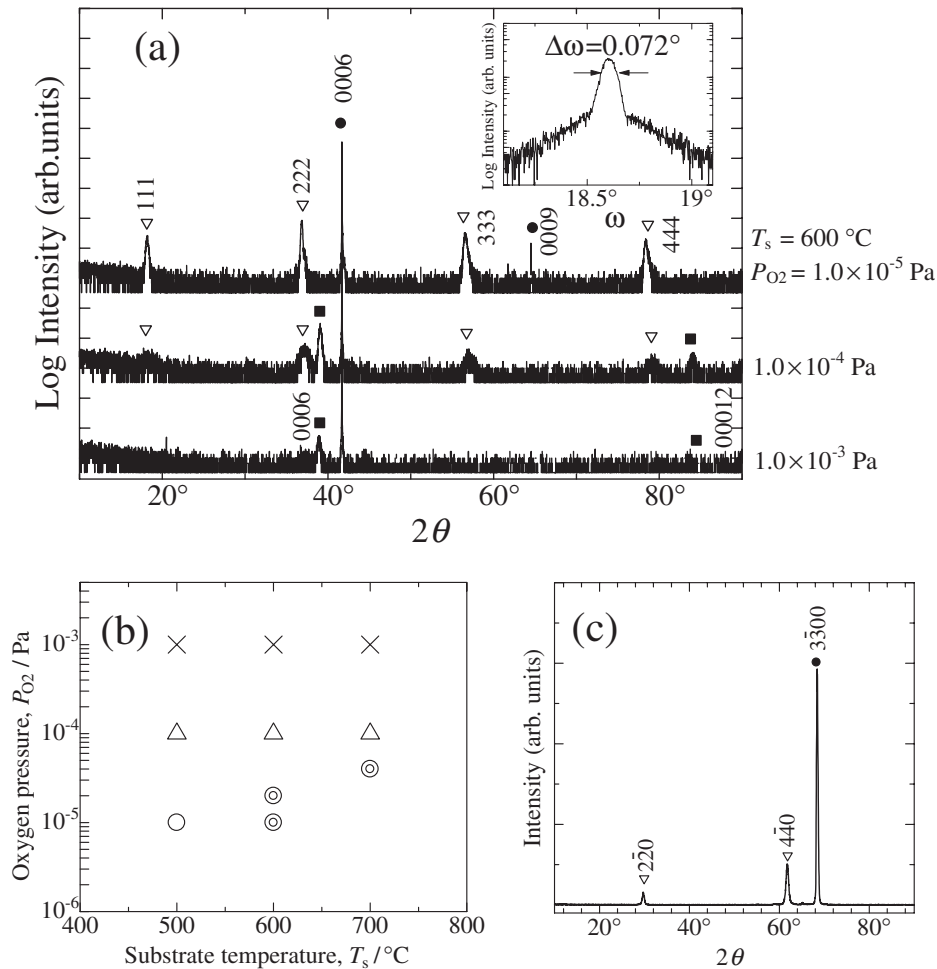


Fig. 1 (a) XRD $2\theta/\omega$ scans of thin films grown under varied oxygen pressure at 600°C . Inset shows the rocking curve of 222 reflection in the $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution thin films grown under 1.0×10^{-5} Pa and at 600°C . ∇ : $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution, \blacksquare : $\text{FeTiO}_3\text{-Fe}_2\text{O}_3$ solid solution, \bullet : $\alpha\text{-Al}_2\text{O}_3$ (substrate). (b) Variation in the crystalline phase with the deposition conditions (T_s and P_{O_2}) \odot : $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution with high crystallinity, \circ : $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution with low crystallinity, \triangle : Coexistence of $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ and $\text{FeTiO}_3\text{-Fe}_2\text{O}_3$ solid solutions, \times : $\text{FeTiO}_3\text{-Fe}_2\text{O}_3$ solid solution. (c) XRD $2\theta_x/\phi$ scan of the thin film grown under 1.0×10^{-5} Pa and at 600°C . ∇ : $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution, \bullet : $\alpha\text{-Al}_2\text{O}_3$ (substrate).

magnetic field and temperature was measured by a superconducting quantum interference device (SQUID) magnetometer (Quantum design, MPMS). Temperature dependence of electric resistivity was explored by the van der Pauw method (Resitest8300, TOYO). Hall effect measurements were performed at room temperature for photolithographically patterned Hall bars using a physical property measurement system (Quantum design, PPMS). To cancel the effect of magnetic field on the longitudinal resistivity, the magnetic field was swept to a positive region and then to a negative region so that only the transverse resistivity, i.e., Hall resistivity, could be obtained by half the difference between the signals measured at the positive and negative fields. In order to determine the major conduction type in thin films, Seebeck coefficient was determined by using two R-type thermocouples attached to both ends of the film, while utilizing a heater to induce a temperature difference of 2 K at room temperature.

3. Results and Discussion

3.1 Structural analysis

Figure 1(a) shows the XRD $2\theta/\omega$ scan profiles of the

thin films grown at $T_s = 600^\circ\text{C}$ and under varied P_{O_2} . The thin film grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa can be identified as a single phase of (111)-oriented spinel-type $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution without any impurity phases. When P_{O_2} is increased to 1.0×10^{-4} Pa, another crystalline phase ascribed to the solid solution of ilmenite (FeTiO_3) and hematite (Fe_2O_3) appears in addition to the $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution. At $P_{\text{O}_2} = 1.0 \times 10^{-3}$ Pa, the diffraction peaks due to the $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution disappear, and only diffraction peaks due to the $\text{FeTiO}_3\text{-Fe}_2\text{O}_3$ solid solution are detected. Figure 1(b) summarizes the change in crystalline phase with the deposition conditions (T_s and P_{O_2}). Both lower P_{O_2} and higher T_s , which promote the formation of Fe^{2+} ions, are effective in stabilizing the spinel phase of $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution without the precipitation of $\text{FeTiO}_3\text{-Fe}_2\text{O}_3$ solid solution. In the inset of Fig. 1(a) is displayed the rocking curve for the 222 reflection of the $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution thin film grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 600^\circ\text{C}$. A single peak is observed with a full width at half maximum (FWHM, $\Delta\omega$) of 0.072° . This value is typical for most of the films with single-phase $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution, except for the sample prepared under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 500^\circ\text{C}$. For the thin film

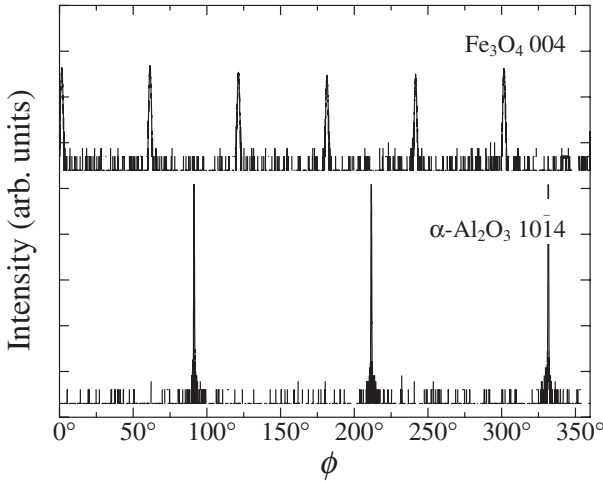


Fig. 2 ϕ -scan of 004 reflection in the solid solution thin film grown under 1.0×10^{-5} Pa and at 600°C . For comparison, ϕ -scan of 10 $\bar{1}$ 4 reflection in sapphire substrate is also shown.

grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa at $T_s = 600^\circ\text{C}$, the out-of-plane lattice parameter was calculated to be 0.8483 nm from the peak position of the 222 reflection shown in Fig. 1(a). In the $2\theta_\chi/\phi$ scan measured for the same film (Fig. 1(c)), the in-plane lattice parameter was estimated to be 0.8496 nm by using the $2\bar{2}0$ reflection. These lattice parameters of the film are very close to that of bulk specimen (0.8489 nm). The small deviation between out-of-plane and in-plane lattice parameters is presumably due to a substrate-induced strain.

To examine the in-plane alignment for the thin films, XRD ϕ -scan was carried out using the 004 reflection ($2\theta = 42.7^\circ$, $\psi = 54.7^\circ$) of the solid solution. A typical result is depicted in Fig. 2 for the thin film composed of the single phase grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 600^\circ\text{C}$. Also shown in the figure is the ϕ -scan in the 10 $\bar{1}$ 4 reflection ($2\theta = 35.141^\circ$, $\psi = 38.236^\circ$) of the c -sapphire substrate. The (0001) surface of substrate has threefold symmetry, so that only three peaks are observed in the ϕ -scan from 0° to 360° . If the resultant film is a perfect single crystal, only three peaks should be detected at every 120° in the ϕ -scan due to the threefold symmetry relative to the [111] direction. For the present film, however, six peaks corresponding to the sixfold symmetry are observed, indicating that the thin film has two crystallographic domains turned by 60° or 180° with each other on the surface of c -sapphire substrate. The formation of twinned in-plane alignment is ascribable to the large lattice mismatch (10.7%) between the solid solution thin film and the c -sapphire substrate.¹¹⁾ Based on the results shown in Figs. 1 and 2, the epitaxial relation can be evaluated to be; $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution (111) \parallel $\alpha\text{-Al}_2\text{O}_3$ (0001) and $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution [1 $\bar{1}$ 0] \parallel $\alpha\text{-Al}_2\text{O}_3$ [$\bar{1}$ 100] and [1 $\bar{1}$ 00].

3.2 Physical properties

Figure 3 shows the temperature dependence of magnetization, M , for the solid solution thin film grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 600^\circ\text{C}$. The measurements were performed under field-cooling condition with an external magnetic field, H , of 0.85 T applied parallel to the

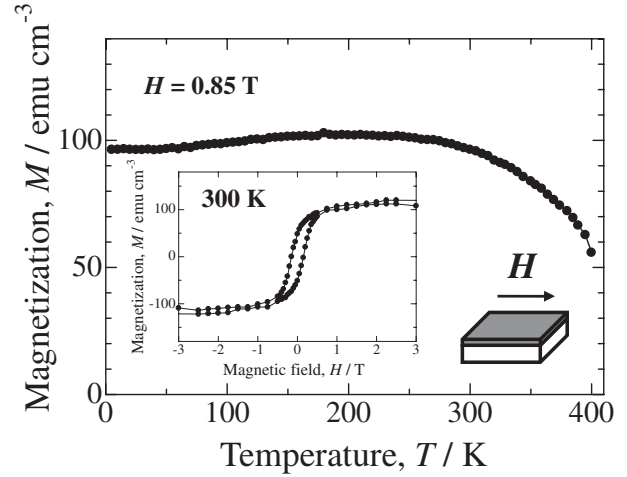


Fig. 3 Temperature dependence of magnetization, M , for the solid solution thin film measured under field-cooling condition at $H = 0.85$ T. Inset shows room-temperature M - H curve.

thin film surface. One can see that M exhibits a plateau at 5 to 300 K and begins to decrease above 300 K, but does not reach zero even at 400 K. This observation indicates that the solid solution thin film shows ferrimagnetism with T_c above 400 K. The inset of Fig. 3 displays the in-plane M - H curve at room-temperature for the solid solution thin film. The M - H curve exhibits an obvious hysteresis loop with saturation magnetization of $0.81 \mu_B/\text{mol}$ at room temperature ($1.0 \mu_B/\text{mol}$ at 5 K, not shown here). The saturation magnetization of the present thin film is smaller compared with the value of single crystal ($1.5 \mu_B/\text{mol}$ at 77 K).⁹⁾ This is generally explained by the presence of antiphase boundaries (APBs) where anti-ferromagnetic interactions are dominant in the films.^{12,13)} APBs are structural defects formed during the growth process, and are observed when growing Fe_3O_4 epitaxial thin films.¹⁴⁻¹⁶⁾

In Fig. 4(a) is depicted the temperature dependence of electric resistivity, ρ_{xx} , for the solid solution thin film grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 600^\circ\text{C}$. A typical semiconducting behavior is observed between 77 and 325 K. The value of ρ_{xx} at 300 K is $0.87 \Omega\text{cm}$, which is almost consistent with those of single crystals.¹⁰⁾ For the purpose of evaluating the conduction mechanism, two types of analyses were performed as shown Figs. 4(b) and (c). In a high temperature range between 100 and 325 K, the relation between logarithmic ρ_{xx} and reciprocal temperature (T^{-1}) exhibits Arrhenius-type behavior as shown in Fig. 4(b):

$$\rho_{xx} = \rho_0 \exp(E_g/k_B T), \quad (1)$$

where ρ_0 , E_g , and k_B are the preexponential term, the activation energy, and the Boltzmann constant, respectively. The E_g is estimated to be 0.055 eV from the slope of the line. On the other hand, the $\log \rho_{xx} - T^{-1}$ plot in a low temperature range obviously shows deviation from the linear relation. In a temperature range from 77 to 160 K, a linear relationship is observed between $\log \rho$ and $T^{-1/4}$ as shown in Fig. 4(c), following the Mott formula ($T^{-1/4}$ law).¹⁷⁾

$$\rho_{xx} = \rho_0 \exp(T_0/T)^{1/4}, \quad (2)$$

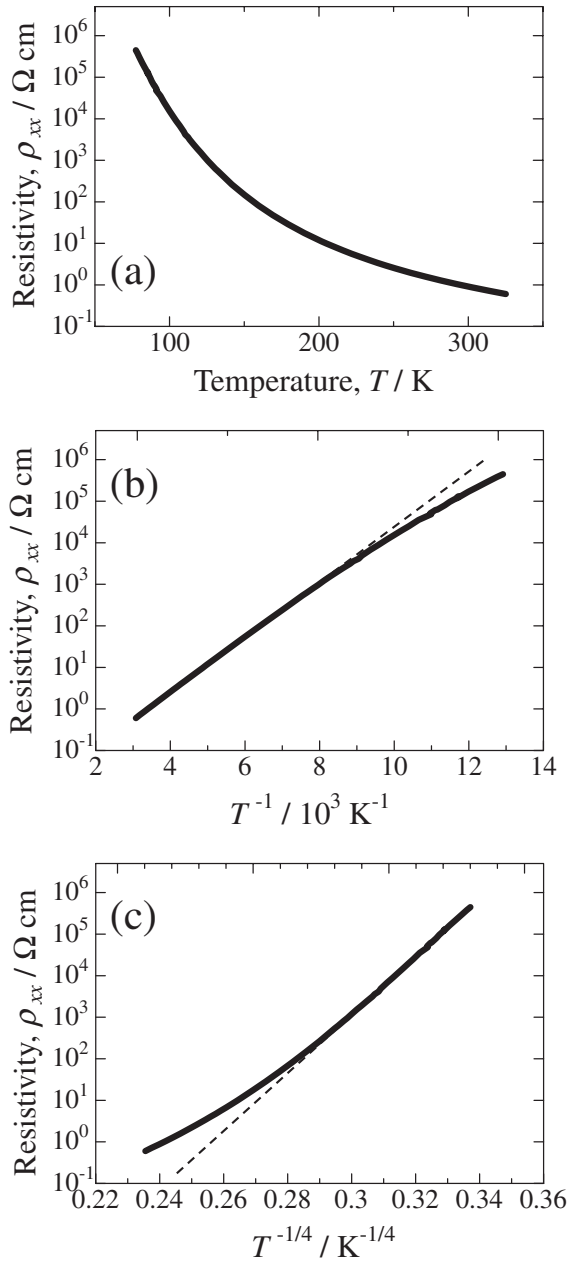


Fig. 4 (a) Temperature dependence of electric resistivity, ρ_{xx} , for solid solution thin film. Dependence of $\log \rho_{xx}$ on (b) T^{-1} and (c) $T^{-1/4}$.

where T_0 is the Mott temperature. This conducting behavior is derived from the variable range hopping (VRH). From these plots, the conduction behavior is found to change from the VRH to the simple thermal-activated hopping at a critical temperature (141 K), suggesting that the charge carriers in the solid solution thin film localize at low temperatures. The Seebeck coefficient of the thin film was evaluated to be $-6.0 \mu\text{V/K}$, which is coincident with the value of bulk sample as reported previously.¹⁰ The negative Seebeck coefficient indicates that the charge carrier is an electron (n -type).

Figure 5 shows the magnetic field dependence of the Hall resistivity, ρ_H , measured at room temperature for the thin film grown under $P_{\text{O}_2} = 1.0 \times 10^{-5}$ Pa and at $T_s = 600^\circ\text{C}$. The magnetic field was applied perpendicular to the thin film surface. We found that ρ_H is negative at room temperature

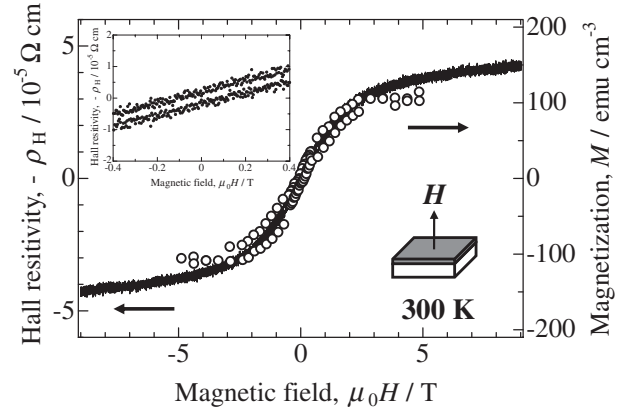


Fig. 5 Magnetic field dependence of $-\rho_H$ and magnetization (open circles) for solid solution thin film. The inset shows a magnified view of magnetic field dependence of $-\rho_H$.

(this is why $-\rho_H$ is plotted in the ordinate of Fig. 5). The plot of out-of-plane M - H curve is also illustrated in Fig. 5. The hysteresis behavior of out-of-plane M - H curve is smaller than that of in-plane shown in Fig. 3, suggesting the presence of easy axis of magnetization in the in-plane direction. In ferromagnetic materials, the Hall resistivity is generally expressed as¹⁸⁾

$$\rho_H = R_O \mu_0 H + R_A \mu_0 M, \quad (3)$$

where R_O is the ordinary Hall coefficient, R_A is the anomalous Hall coefficient, and μ_0 is the vacuum permeability. The first term of eq. (3), proportional to H , describe the ordinary Hall effect (OHE), and the second term, in general much larger than the first one, denotes the anomalous Hall effect (AHE), which is proportional to M of the material. The OHE arises from the Lorentz forces acting on charge carriers. On the other hand, although the origin of AHE has been a controversial issue for decades,^{19–22)} it has been considered that AHE in a ferromagnetic material provides a strong evidence of intrinsic ferromagnetism caused by spin-polarized charge carriers that mediate ferromagnetic exchange interaction between localized spins of magnetic ions distant from each other.²²⁾ As shown in Fig. 5, ρ_H exhibits a behavior similar to that of out-of-plane M - H curve, especially in the low magnetic fields. The result suggests that $0.4\text{Fe}_3\text{O}_4 \cdot 0.6\text{Fe}_2\text{TiO}_4$ solid solution thin film has spin-polarized charge carriers at room temperature. From the slope of the line at high magnetic fields caused by OHE, we can obtain $R_O = -1.17 \times 10^{-2} \text{ cm}^3/\text{C}$ at room temperature, indicating n -type conduction, consistent with the Seebeck effect measurement. The carrier density, n , determined by using the relation $R_O = 1/en$ is $5.35 \times 10^{20} \text{ cm}^{-3}$. The Hall mobility derived from R_O and conductivity ($1/\rho_{xx}$) is $0.01 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$. Substituting the saturation magnetization (102 emu cm^{-3}) into the second term of eq. (3) yields $R_A = -2.48 \text{ cm}^3/\text{C}$ at room temperature. The negative value of R_A has been commonly observed in Fe_3O_4 ($R_A = -0.25 \text{ cm}^3/\text{C}$) and related compounds.²³⁾ In order to clarify the mechanism of AHE in more detail, a relation between ρ_H and ρ_{xx} should be investigated in a systematic fashion as reported in literatures.^{24–26)}

4. Conclusion

We have fabricated 40-nm-thick $0.4\text{Fe}_3\text{O}_4\text{-}0.6\text{Fe}_2\text{TiO}_4$ solid solution thin films with spinel-type structure on *c*-sapphire substrates by using a PLD technique, and examined their structural, electrical, and magnetic properties. The solid solution thin films are epitaxially grown on the sapphire substrate, although they have a preferential in-plane orientation due to the large lattice mismatch between the thin film and the substrate. The crystallographic relationship is $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution (111) \parallel $\alpha\text{-Al}_2\text{O}_3$ (0001) and $\text{Fe}_3\text{O}_4\text{-Fe}_2\text{TiO}_4$ solid solution [110] \parallel $\alpha\text{-Al}_2\text{O}_3$ [1100] and [1100]. The solid solution thin film is ferrimagnetic with T_c higher than 400°C, and shows *n*-type conduction. The conduction behavior changes from the simple thermal-activated hopping to the VRH at a critical temperature (141 K) due to the localization of electrons at low temperatures. The presence of spin-polarized charge carriers is suggested by the Hall effect measurement at room temperature. These results imply that the solid solution thin film can be a promising candidate for semiconductor spintronics devices.

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